

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	5518042	peel\$4 or de\$1laminat\$4 or detach\$5 or separat\$5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/19 09:59
S2	11848683	tungsten or w or ti or titanium or ta or tantalum or mo or molybdenum or co or cobalt or zn or zinc or zr or zirconium or ni or nickel or nd or neodymium	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 17:10
S3	891378	oxidi\$7 or oxidat\$5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 17:13
S4	252943	S3 with (S2 or metal\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/19 10:00
S5	693179	oxide near7 (S2 or metal\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/19 10:03
S6	367260	(S4 or S5) and S1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 17:18
S7	80236	(support or temporar\$5) near5 substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 18:37
S8	3199990	bond\$3 or bind\$3 or adhes\$5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 18:32

S9	10732	S6 and S7 and S8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 17:21
S10	3912395	semiconductor or si or silicon	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 17:21
S11	8290	S9 and S10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 17:21
S12	2556788	tft or thin adj3 film or el or electro\$1optic\$4 or led or image adj3 display or light adj3 emit\$4 or lcd or liquid adj3 crystal	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 17:25
S13	5498	S11 and S12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 17:27
S14	73720	S1 same S5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 17:28
S15	18715	S4 and S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 17:28
S16	503	S15 and S10 and S7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 17:29

S17	300	S16 and S12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 17:29
S18	2174492	substrate or wafer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 18:31
S19	6528493	bond\$3 or bind\$3 or adhe\$6 or attach\$6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 18:36
S20	99718	(support or temporar\$5) near5 (wafer or substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 18:37
S21	17309	(S19 or glu\$4) near25 S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 18:40
S22	3438	S21 and (S4 or S5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 18:40
S23	191502	S1 near20 (substrate or wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 18:41
S24	1724	S22 and S23	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 18:43

S25	1444	S24 and S10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 18:45
S26	1771	(438/458 or 438/795 or 438/928). ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/19 09:59
S27	5518042	peel\$4 or de\$1laminat\$4 or detach\$5 or separat\$5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/19 09:59
S28	11848683	tungsten or w or ti or titanium or ta or tantalum or mo or molybdenum or co or cobalt or zn or zinc or zr or zirconium or ni or nickel or nd or neodymium	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/19 10:00
S29	891378	oxidi\$7 or oxidat\$5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/19 10:00
S30	252943	S29 with (S28 or metal\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/19 10:00
S31	693179	oxide near7 (S28 or metal\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/19 10:05
S32	395	S26 and S27 and (S30 or S31)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/19 10:06
S33	1	("20030024635").PN.	US-PGPUB; USPAT	OR	OFF	2005/03/19 15:08